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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Obsolete
Number of LABs/CLBs	8962
Number of Logic Elements/Cells	190000
Total RAM Bits	13284352
Number of I/O	384
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FBGA (31x31)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/5agxba5d6f31c6n">https://www.e-xfl.com/product-detail/intel/5agxba5d6f31c6n</a>

## I/O Standard Specifications

Tables in this section list the input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by Arria V devices.

You must perform timing closure analysis to determine the maximum achievable frequency for general purpose I/O standards.

### Single-Ended I/O Standards

**Table 1-14: Single-Ended I/O Standards for Arria V Devices**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}^{(13)}$ (mA)	$I_{OH}^{(13)}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3-V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3-V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	2	-2
3.0-V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
3.0-V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
3.0-V PCI	2.85	3	3.15	—	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

<sup>(13)</sup> To meet the  $I_{OL}$  and  $I_{OH}$  specifications, you must set the current strength settings accordingly. For example, to meet the 3.3-V LVTTL specification (4 mA), you should set the current strength settings to 4 mA. Setting at lower current strength may not meet the  $I_{OL}$  and  $I_{OH}$  specifications in the datasheet.

I/O Standard	$V_{CCIO}$ (V)			$V_{ID}$ (mV) <sup>(16)</sup>			$V_{ICM(DC)}$ (V)			$V_{OD}$ (V) <sup>(17)</sup>			$V_{OCM}$ (V) <sup>(17)(18)</sup>		
	Min	Typ	Max	Min	Condition	Max	Min	Condition	Max	Min	Typ	Max	Min	Typ	Max
PCML	Transmitter, receiver, and input reference clock pins of high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Transceiver Specifications for Arria V GX and SX Devices and Transceiver Specifications for Arria V GT and ST Devices tables.														
2.5 V LVDS <sup>(19)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	$D_{MAX} \leq 1.25$ Gbps	1.80	0.247	—	0.6	1.125	1.25	1.375
						—	1.05	$D_{MAX} > 1.25$ Gbps	1.55						
RSDS (HIO) <sup>(20)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.25	—	1.45	0.1	0.2	0.6	0.5	1.2	1.4
Mini-LVDS (HIO) <sup>(21)</sup>	2.375	2.5	2.625	200	—	600	0.300	—	1.425	0.25	—	0.6	1	1.2	1.4
LVPECL <sup>(22)</sup>	—	—	—	300	—	—	0.60	$D_{MAX} \leq 700$ Mbps	1.80	—	—	—	—	—	—
							1.00	$D_{MAX} > 700$ Mbps	1.60						

**Related Information**

- [Transceiver Specifications for Arria V GX and SX Devices](#) on page 1-23  
Provides the specifications for transmitter, receiver, and reference clock I/O pin.

<sup>(16)</sup> The minimum  $V_{ID}$  value is applicable over the entire common mode range,  $V_{CM}$ .

<sup>(17)</sup>  $R_L$  range:  $90 \leq R_L \leq 110 \Omega$ .

<sup>(18)</sup> This applies to default pre-emphasis setting only.

<sup>(19)</sup> For optimized LVDS receiver performance, the receiver voltage input range must be within 1.0 V to 1.6 V for data rates above 1.25 Gbps and 0 V to 1.85 V for data rates below 1.25 Gbps.

<sup>(20)</sup> For optimized RSDS receiver performance, the receiver voltage input range must be within 0.25 V to 1.45 V.

<sup>(21)</sup> For optimized Mini-LVDS receiver performance, the receiver voltage input range must be within 0.3 V to 1.425 V.

<sup>(22)</sup> For optimized LVPECL receiver performance, the receiver voltage input range must be within 0.85 V to 1.75 V for data rates above 700 Mbps and 0.45 V to 1.95 V for data rates below 700 Mbps.

Symbol/Description	Condition	Transceiver Speed Grade 3			Unit
		Min	Typ	Max	
Differential on-chip termination resistors	85- $\Omega$ setting	—	85	—	$\Omega$
	100- $\Omega$ setting	—	100	—	$\Omega$
	120- $\Omega$ setting	—	120	—	$\Omega$
	150- $\Omega$ setting	—	150	—	$\Omega$
Intra-differential pair skew	TX $V_{CM} = 0.65$ V (AC coupled) and slew rate of 15 ps	—	—	15	ps
Intra-transceiver block transmitter channel-to-channel skew	$\times 6$ PMA bonded mode	—	—	180	ps
Inter-transceiver block transmitter channel-to-channel skew <sup>(55)</sup>	$\times N$ PMA bonded mode	—	—	500	ps

Table 1-30: CMU PLL Specifications for Arria V GT and ST Devices

Symbol/Description	Transceiver Speed Grade 3		Unit
	Min	Max	
Supported data range	0.611	10.3125	Gbps
fPLL supported data range	611	3125	Mbps

<sup>(55)</sup> This specification is only applicable to channels on one side of the device across two transceiver banks.

Table 1-31: Transceiver-FPGA Fabric Interface Specifications for Arria V GT and ST Devices

Symbol/Description	Transceiver Speed Grade 3		Unit
	Min	Max	
Interface speed (PMA direct mode)	50	153.6 <sup>(56)</sup> , 161 <sup>(57)</sup>	MHz
Interface speed (single-width mode)	25	187.5	MHz
Interface speed (double-width mode)	25	163.84	MHz

**Related Information**

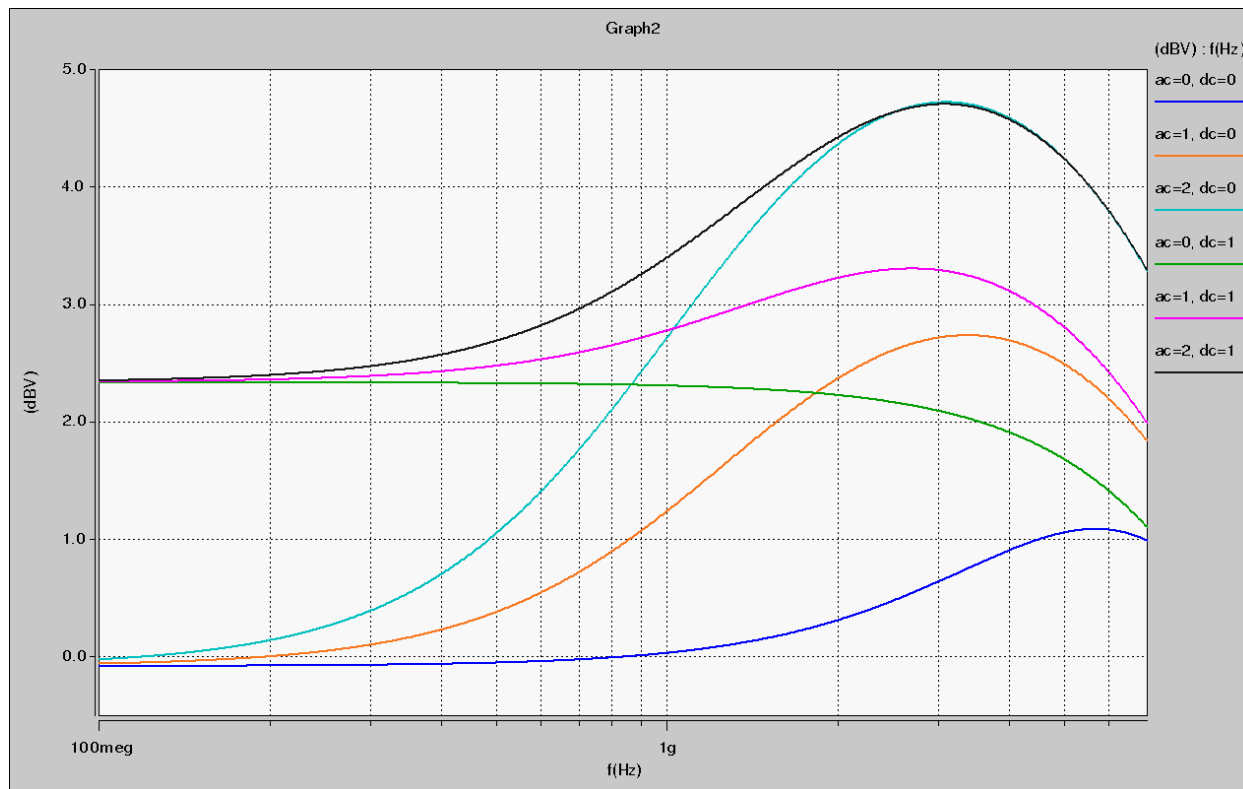
- [CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 1-35
- [CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 1-36

<sup>(56)</sup> The maximum frequency when core transceiver local routing is selected.

<sup>(57)</sup> The maximum frequency when core transceiver network routing (GCLK, RCLK, or PCLK) is selected.

## CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain

Figure 1-2: Continuous Time-Linear Equalizer (CTLE) Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices



Symbol	Parameter	Condition	Min	Typ	Max	Unit
$f_{\text{OUT\_EXT}}$	Output frequency for external clock output	–3 speed grade	—	—	670 <sup>(63)</sup>	MHz
		–4 speed grade	—	—	670 <sup>(63)</sup>	MHz
		–5 speed grade	—	—	622 <sup>(63)</sup>	MHz
		–6 speed grade	—	—	500 <sup>(63)</sup>	MHz
$t_{\text{OUTDUTY}}$	Duty cycle for external clock output (when set to 50%)	—	45	50	55	%
$t_{\text{FCOMP}}$	External feedback clock compensation time	—	—	—	10	ns
$t_{\text{DYCONFIGCLK}}$	Dynamic configuration clock for <code>mgmt_clk</code> and <code>scanclk</code>	—	—	—	100	MHz
$t_{\text{LOCK}}$	Time required to lock from end-of-device configuration or deassertion of <code>areset</code>	—	—	—	1	ms
$t_{\text{DLOCK}}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	—	1	ms
$f_{\text{CLBW}}$	PLL closed-loop bandwidth	Low	—	0.3	—	MHz
		Medium	—	1.5	—	MHz
		High <sup>(64)</sup>	—	4	—	MHz
$t_{\text{PLL\_PSERR}}$	Accuracy of PLL phase shift	—	—	—	±50	ps
$t_{\text{ARESET}}$	Minimum pulse width on the <code>areset</code> signal	—	10	—	—	ns
$t_{\text{INCCJ}}^{(65)(66)}$	Input clock cycle-to-cycle jitter	$F_{\text{REF}} \geq 100 \text{ MHz}$	—	—	0.15	UI (p-p)
		$F_{\text{REF}} < 100 \text{ MHz}$	—	—	±750	ps (p-p)

<sup>(64)</sup> High bandwidth PLL settings are not supported in external feedback mode.<sup>(65)</sup> A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source with jitter < 120 ps.<sup>(66)</sup>  $F_{\text{REF}}$  is  $f_{\text{IN}}/N$ , specification applies when  $N = 1$ .

Symbol	Parameter	Condition	Min	Typ	Max	Unit
$t_{\text{OUTPJ\_DC}}^{(67)}$	Period jitter for dedicated clock output in integer PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	175	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	17.5	mUI (p-p)
$t_{\text{FOUTPJ\_DC}}^{(67)}$	Period jitter for dedicated clock output in fractional PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	250 <sup>(68)</sup> , 175 <sup>(69)</sup>	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	25 <sup>(68)</sup> , 17.5 <sup>(69)</sup>	mUI (p-p)
$t_{\text{OUTCCJ\_DC}}^{(67)}$	Cycle-to-cycle jitter for dedicated clock output in integer PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	175	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	17.5	mUI (p-p)
$t_{\text{FOUTCCJ\_DC}}^{(67)}$	Cycle-to-cycle jitter for dedicated clock output in fractional PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	250 <sup>(68)</sup> , 175 <sup>(69)</sup>	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	25 <sup>(68)</sup> , 17.5 <sup>(69)</sup>	mUI (p-p)
$t_{\text{OUTPJ\_IO}}^{(67)(70)}$	Period jitter for clock output on a regular I/O in integer PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	600	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	60	mUI (p-p)
$t_{\text{FOUTPJ\_IO}}^{(67)(68)(70)}$	Period jitter for clock output on a regular I/O in fractional PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	600	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	60	mUI (p-p)
$t_{\text{OUTCCJ\_IO}}^{(67)(70)}$	Cycle-to-cycle jitter for clock output on a regular I/O in integer PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	600	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	60	mUI (p-p)
$t_{\text{FOUTCCJ\_IO}}^{(67)(68)(70)}$	Cycle-to-cycle jitter for clock output on a regular I/O in fractional PLL	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	600	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	60	mUI (p-p)

<sup>(67)</sup> Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in Memory Output Clock Jitter Specification for Arria V Devices table.

<sup>(68)</sup> This specification only covered fractional PLL for low bandwidth. The  $f_{\text{VCO}}$  for fractional value range 0.05–0.95 must be  $\geq 1000 \text{ MHz}$ .

<sup>(69)</sup> This specification only covered fractional PLL for low bandwidth. The  $f_{\text{VCO}}$  for fractional value range 0.20–0.80 must be  $\geq 1200 \text{ MHz}$ .

<sup>(70)</sup> External memory interface clock output jitter specifications use a different measurement method, which are available in Memory Output Clock Jitter Specification for Arria V Devices table.



Symbol	Parameter	Condition	Min	Typ	Max	Unit
$t_{\text{CASC\_OUTPJ\_DC}}^{(67)(71)}$	Period jitter for dedicated clock output in cascaded PLLs	$F_{\text{OUT}} \geq 100 \text{ MHz}$	—	—	175	ps (p-p)
		$F_{\text{OUT}} < 100 \text{ MHz}$	—	—	17.5	mUI (p-p)
$t_{\text{DRIFT}}$	Frequency drift after $\text{PFDENA}$ is disabled for a duration of 100 $\mu\text{s}$	—	—	—	$\pm 10$	%
$dK_{\text{BIT}}$	Bit number of Delta Sigma Modulator (DSM)	—	8	24	32	bits
$k_{\text{VALUE}}$	Numerator of fraction	—	128	8388608	2147483648	—
$f_{\text{RES}}$	Resolution of VCO frequency	$f_{\text{INPFD}} = 100 \text{ MHz}$	390625	5.96	0.023	Hz

**Related Information**

[Memory Output Clock Jitter Specifications](#) on page 1-57

Provides more information about the external memory interface clock output jitter specifications.

<sup>(71)</sup> The cascaded PLL specification is only applicable with the following conditions:

- Upstream PLL:  $0.59 \text{ MHz} \leq \text{Upstream PLL BW} < 1 \text{ MHz}$
- Downstream PLL:  $\text{Downstream PLL BW} > 2 \text{ MHz}$

Symbol	Description	Min	Max	Unit
$T_h$	SPI MISO hold time	1	—	ns
$T_{\text{duty cycle}}$	SPI_CLK duty cycle	45	55	%
$T_{\text{dssfrst}}$	Output delay SPI_SS valid before first clock edge	8	—	ns
$T_{\text{dsslst}}$	Output delay SPI_SS valid after last clock edge	8	—	ns
$T_{\text{dio}}$	Master-out slave-in (MOSI) output delay	–1	1	ns

<sup>(86)</sup> This value is based on  $\text{rx\_sample\_dly} = 1$  and  $\text{spi\_m\_clk} = 120$  MHz.  $\text{spi\_m\_clk}$  is the internal clock that is used by SPI Master to derive its  $\text{SCLK\_OUT}$ . These timings are based on  $\text{rx\_sample\_dly}$  of 1. This delay can be adjusted as needed to accommodate slower response times from the slave. Note that a delay of 0 is not allowed. The setup time can be used as a reference starting point. It is very crucial to do a calibration to get the correct  $\text{rx\_sample\_dly}$  value because each SPI slave device may have different output delay and each application board may have different path delay. For more information about  $\text{rx\_sample\_delay}$ , refer to the SPI Controller chapter in the Hard Processor System Technical Reference Manual.

## HPS JTAG Timing Specifications

**Table 1-62: HPS JTAG Timing Parameters and Values for Arria V Devices**

Symbol	Description	Min	Max	Unit
$t_{JCP}$	TCK clock period	30	—	ns
$t_{JCH}$	TCK clock high time	14	—	ns
$t_{JCL}$	TCK clock low time	14	—	ns
$t_{JPSU}$ (TDI)	TDI JTAG port setup time	2	—	ns
$t_{JPSU}$ (TMS)	TMS JTAG port setup time	3	—	ns
$t_{JPH}$	JTAG port hold time	5	—	ns
$t_{JPCO}$	JTAG port clock to output	—	12 <sup>(90)</sup>	ns
$t_{JPZX}$	JTAG port high impedance to valid output	—	14 <sup>(90)</sup>	ns
$t_{JPXZ}$	JTAG port valid output to high impedance	—	14 <sup>(90)</sup>	ns

## Configuration Specifications

This section provides configuration specifications and timing for Arria V devices.

### POR Specifications

**Table 1-63: Fast and Standard POR Delay Specification for Arria V Devices**

POR Delay	Minimum	Maximum	Unit
Fast	4	12 <sup>(91)</sup>	ms

<sup>(90)</sup> A 1-ns adder is required for each  $V_{CCIO\_HPS}$  voltage step down from 3.0 V. For example,  $t_{JPCO}$  = 13 ns if  $V_{CCIO\_HPS}$  of the TDO I/O bank = 2.5 V, or 14 ns if it equals 1.8 V.

<sup>(91)</sup> The maximum pulse width of the fast POR delay is 12 ms, providing enough time for the PCIe hard IP to initialize after the POR trip.

Variant	Member Code	Active Serial <sup>(108)</sup>			Fast Passive Parallel <sup>(109)</sup>		
		Width	DCLK (MHz)	Minimum Configuration Time (ms)	Width	DCLK (MHz)	Minimum Configuration Time (ms)
Arria V GX	A1	4	100	178	16	125	36
	A3	4	100	178	16	125	36
	A5	4	100	255	16	125	51
	A7	4	100	255	16	125	51
	B1	4	100	344	16	125	69
	B3	4	100	344	16	125	69
	B5	4	100	465	16	125	93
	B7	4	100	465	16	125	93
Arria V GT	C3	4	100	178	16	125	36
	C7	4	100	255	16	125	51
	D3	4	100	344	16	125	69
	D7	4	100	465	16	125	93
Arria V SX	B3	4	100	465	16	125	93
	B5	4	100	465	16	125	93
Arria V ST	D3	4	100	465	16	125	93
	D5	4	100	465	16	125	93

**Related Information****Configuration Files** on page 1-83<sup>(108)</sup> DCLK frequency of 100 MHz using external CLKUSR.<sup>(109)</sup> Maximum FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

Date	Version	Changes
December 2015	2015.12.16	<ul style="list-style-type: none"><li>Updated Quad Serial Peripheral Interface (SPI) Flash Timing Requirements for Arria V Devices table.<ul style="list-style-type: none"><li>Updated <math>F_{clk}</math>, <math>T_{duty\ cycle}</math>, and <math>T_{dss\ first}</math> specifications.</li><li>Added <math>T_{qspi\_clk}</math>, <math>T_{din\_start}</math>, and <math>T_{din\_end}</math> specifications.</li><li>Removed <math>T_{din\ max}</math> specifications.</li></ul></li><li>Updated the minimum specification for <math>T_{clk}</math> to 16.67 ns and removed the maximum specification in SPI Master Timing Requirements for Arria V Devices table.</li><li>Updated Secure Digital (SD)/MultiMediaCard (MMC) Timing Requirements for Arria V Devices table.<ul style="list-style-type: none"><li>Updated <math>T_{clk}</math> to <math>T_{sdmmc\_clk\_out}</math> symbol.</li><li>Updated <math>T_{sdmmc\_clk\_out}</math> and <math>T_d</math> specifications.</li><li>Added <math>T_{sdmmc\_clk}</math>, <math>T_{su}</math>, and <math>T_h</math> specifications.</li><li>Removed <math>T_{din\ max}</math> specifications.</li></ul></li><li>Updated the following diagrams:<ul style="list-style-type: none"><li>Quad SPI Flash Timing Diagram</li><li>SD/MMC Timing Diagram</li></ul></li><li>Updated configuration .rbf sizes for Arria V devices.</li><li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li></ul>

Date	Version	Changes
June 2015	2015.06.16	<ul style="list-style-type: none"> <li>Added the supported data rates for the following output standards using true LVDS output buffer types in the High-Speed I/O Specifications for Arria V Devices table: <ul style="list-style-type: none"> <li>True RSDS output standard: data rates of up to 360 Mbps</li> <li>True mini-LVDS output standard: data rates of up to 400 Mbps</li> </ul> </li> <li>Added note in the condition for Transmitter—Emulated Differential I/O Standards <math>f_{\text{HSDR}}</math> data rate parameter in the High-Speed I/O Specifications for Arria V Devices table. Note: When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.</li> <li>Changed Queued Serial Peripheral Interface (QSPI) to Quad Serial Peripheral Interface (SPI) Flash.</li> <li>Updated <math>T_h</math> location in I<sup>2</sup>C Timing Diagram.</li> <li>Updated <math>T_{\text{wp}}</math> location in NAND Address Latch Timing Diagram.</li> <li>Corrected the unit for <math>t_{\text{DH}}</math> from ns to s in FPP Timing Parameters When DCLK-to-DATA[] Ratio is &gt;1 for Arria V Devices table.</li> <li>Updated the maximum value for <math>t_{\text{CO}}</math> from 4 ns to 2 ns in AS Timing Parameters for AS <math>\times 1</math> and <math>\times 4</math> Configurations in Arria V Devices table.</li> <li>Moved the following timing diagrams to the Configuration, Design Security, and Remote System Upgrades in Arria V Devices chapter. <ul style="list-style-type: none"> <li>FPP Configuration Timing Waveform When DCLK-to-DATA[] Ratio is 1</li> <li>FPP Configuration Timing Waveform When DCLK-to-DATA[] Ratio is &gt;1</li> <li>AS Configuration Timing Waveform</li> <li>PS Configuration Timing Waveform</li> </ul> </li> </ul>

Date	Version	Changes
June 2012	2.0	<ul style="list-style-type: none"><li>• Updated for the Quartus II software v12.0 release:</li><li>• Restructured document.</li><li>• Updated “Supply Current and Power Consumption” section.</li><li>• Updated Table 20, Table 21, Table 24, Table 25, Table 26, Table 35, Table 39, Table 43, and Table 52.</li><li>• Added Table 22, Table 23, and Table 33.</li><li>• Added Figure 1–1 and Figure 1–2.</li><li>• Added “Initialization” and “Configuration Files” sections.</li></ul>
February 2012	1.3	<ul style="list-style-type: none"><li>• Updated Table 2–1.</li><li>• Updated Transceiver-FPGA Fabric Interface rows in Table 2–20.</li><li>• Updated <math>V_{CCP}</math> description.</li></ul>
December 2011	1.2	Updated Table 2–1 and Table 2–3.
November 2011	1.1	<ul style="list-style-type: none"><li>• Updated Table 2–1, Table 2–19, Table 2–26, and Table 2–36.</li><li>• Added Table 2–5.</li><li>• Added Figure 2–4.</li></ul>
August 2011	1.0	Initial release.

Symbol	Description	Condition	Minimum <sup>(114)</sup>	Typical	Maximum <sup>(114)</sup>	Unit
V <sub>I</sub>	DC input voltage	—	−0.5	—	3.6	V
V <sub>O</sub>	Output voltage	—	0	—	V <sub>CCIO</sub>	V
T <sub>J</sub>	Operating junction temperature	Commercial	0	—	85	°C
		Industrial	−40	—	100	°C
t <sub>RAMP</sub>	Power supply ramp time	Standard POR	200 μs	—	100 ms	—
		Fast POR	200 μs	—	4 ms	—

### Recommended Transceiver Power Supply Operating Conditions

**Table 2-6: Recommended Transceiver Power Supply Operating Conditions for Arria V GZ Devices**

Symbol	Description	Minimum <sup>(118)</sup>	Typical	Maximum <sup>(118)</sup>	Unit
V <sub>CCA_GXBL</sub> (119), (120)	Transceiver channel PLL power supply (left side)	2.85	3.0	3.15	V
		2.375	2.5	2.625	
V <sub>CCA_GXBR</sub> (119), (120)	Transceiver channel PLL power supply (right side)	2.85	3.0	3.15	V
		2.375	2.5	2.625	
V <sub>CCHIP_L</sub>	Transceiver hard IP power supply (left side)	0.82	0.85	0.88	V
V <sub>CCHSSI_L</sub>	Transceiver PCS power supply (left side)	0.82	0.85	0.88	V
V <sub>CCHSSI_R</sub>	Transceiver PCS power supply (right side)	0.82	0.85	0.88	V

<sup>(114)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(118)</sup> This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(119)</sup> This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.

<sup>(120)</sup> When using ATX PLLs, the supply must be 3.0 V.



## Hot Socketing

Table 2-14: Hot Socketing Specifications for Arria V GZ Devices

Symbol	Description	Maximum
$I_{IOPIN} (DC)$	DC current per I/O pin	300 $\mu A$
$I_{IOPIN} (AC)$	AC current per I/O pin	8 mA <sup>(124)</sup>
$I_{XCVR-TX} (DC)$	DC current per transceiver transmitter pin	100 mA
$I_{XCVR-RX} (DC)$	DC current per transceiver receiver pin	50 mA

## Internal Weak Pull-Up Resistor

Table 2-15: Internal Weak Pull-Up Resistor for Arria V GZ Devices

All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins. The internal weak pull-down feature is only available for the JTAG  $TCK$  pin. The typical value for this internal weak pull-down resistor is approximately 25 k $\Omega$ .

Symbol	Description	$V_{CCIO}$ Conditions (V) <sup>(125)</sup>	Value <sup>(126)</sup>	Unit
$R_{PU}$	Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if you enable the programmable pull-up resistor option.	3.0 $\pm 5\%$	25	k $\Omega$
		2.5 $\pm 5\%$	25	k $\Omega$
		1.8 $\pm 5\%$	25	k $\Omega$
		1.5 $\pm 5\%$	25	k $\Omega$
		1.35 $\pm 5\%$	25	k $\Omega$
		1.25 $\pm 5\%$	25	k $\Omega$
		1.2 $\pm 5\%$	25	k $\Omega$

<sup>(124)</sup> The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C dv/dt$ , in which C is the I/O pin capacitance and  $dv/dt$  is the slew rate.

<sup>(125)</sup> The pin pull-up resistance values may be lower if an external source drives the pin higher than  $V_{CCIO}$ .

<sup>(126)</sup> These specifications are valid with a  $\pm 10\%$  tolerance to cover changes over PVT.

## Typical VOD Settings

Table 2-32: Typical  $V_{OD}$  Setting for Arria V GZ Channel, TX Termination = 100  $\Omega$ 

The tolerance is +/-20% for all VOD settings except for settings 2 and below.

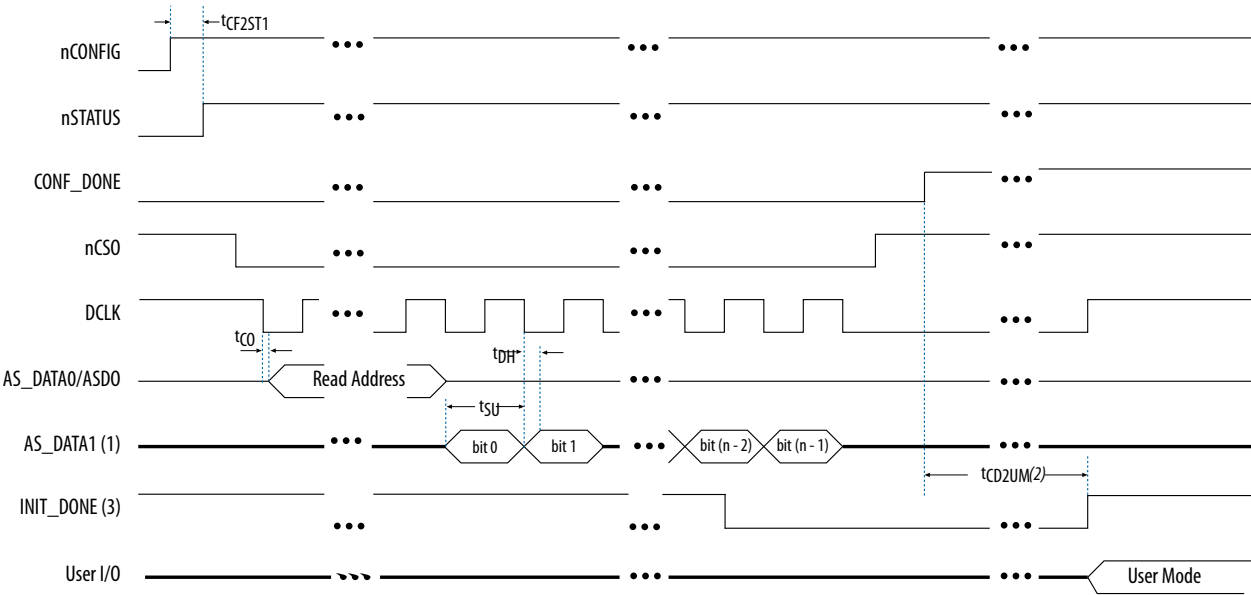
Symbol	$V_{OD}$ Setting	$V_{OD}$ Value (mV)	$V_{OD}$ Setting	$V_{OD}$ Value (mV)
$V_{OD}$ differential peak to peak typical	0 <sup>(166)</sup>	0	32	640
	1 <sup>(166)</sup>	20	33	660
	2 <sup>(166)</sup>	40	34	680
	3 <sup>(166)</sup>	60	35	700
	4 <sup>(166)</sup>	80	36	720
	5 <sup>(166)</sup>	100	37	740
	6	120	38	760
	7	140	39	780
	8	160	40	800
	9	180	41	820
	10	200	42	840
	11	220	43	860
	12	240	44	880
	13	260	45	900
	14	280	46	920

<sup>(166)</sup> If TX termination resistance = 100  $\Omega$ , this VOD setting is illegal.

# Active Serial Configuration Timing

Figure 2-9: AS Configuration Timing

Timing waveform for the active serial (AS) x1 mode and AS x4 mode configuration timing.



- Notes:
- 1. If you are using AS x4 mode, this signal represents the AS\_DATA[3..0] and ERQ sends in 4-bits of data for each DCLK cycle.
  - 2. The initialization clock can be from internal oscillator or CLKUSR pin
  - 3. After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 2-58: AS Timing Parameters for AS x1 and AS x4 Configurations in Arria V GZ Devices

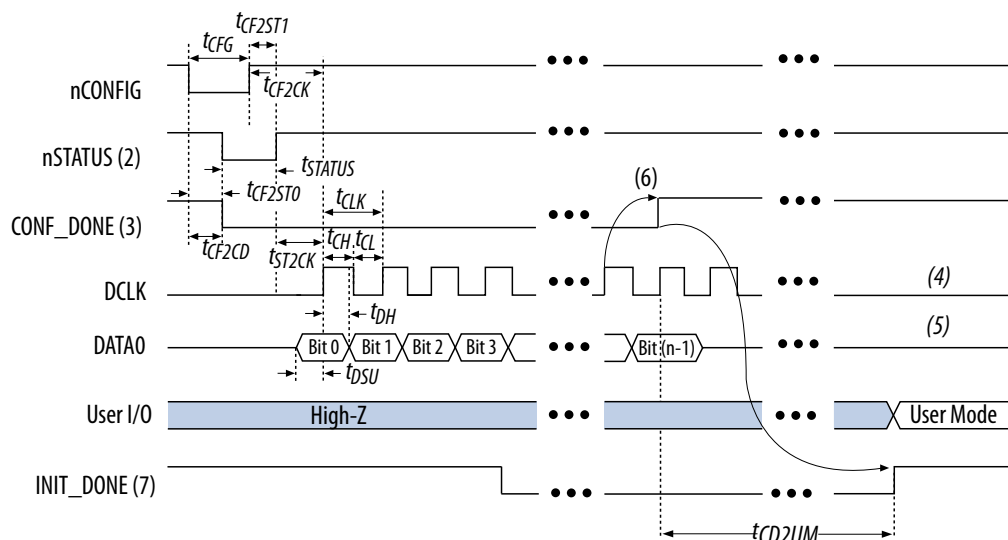
The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.

$t_{CF2CD}$ ,  $t_{CF2ST0}$ ,  $t_{CFG}$ ,  $t_{STATUS}$ , and  $t_{CF2ST1}$  timing parameters are identical to the timing parameters for PS mode listed in the "PS Timing Parameters for Arria V GZ Devices" table.

## Passive Serial Configuration Timing

Figure 2-10: PS Configuration Timing Waveform

Timing waveform for a passive serial (PS) configuration when using a MAX II device, MAX V device, or microprocessor as an external host.



### Notes:

1. The beginning of this waveform shows the device in user mode. In user mode, **nCONFIG**, **nSTATUS**, and **CONF\_DONE** are at logic high levels. When **nCONFIG** is pulled low, a reconfiguration cycle begins.
2. After power-up, the Arria V GZ device holds **nSTATUS** low for the time of the POR delay.
3. After power-up, before and during configuration, **CONF\_DONE** is low.
4. Do not leave **DCLK** floating after configuration. **DCLK** is ignored after configuration is complete. It can toggle high or low if required.
5. **DATA0** is available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings in the Device and Pins Option.
6. To ensure a successful configuration, send the entire configuration data to the Arria V GZ device. **CONF\_DONE** is released high after the Arria V GZ device receives all the configuration data successfully. After **CONF\_DONE** goes high, send two additional falling edges on **DCLK** to begin initialization and enter user mode.
7. After the option bit to enable the **INIT\_DONE** pin is configured into the device, the **INIT\_DONE** goes low.

## Related Information

## Configuration, Design Security, and Remote System Upgrades in Arria V Devices

## Initialization

Table 2-61: Initialization Clock Source Option and the Maximum Frequency for Arria V GZ Devices

Initialization Clock Source	Configuration Schemes	Maximum Frequency (MHz)	Minimum Number of Clock Cycles
Internal Oscillator	AS, PS, FPP	12.5	8576
CLKUSR <sup>(222)</sup>	PS, FPP	125	
	AS	100	
DCLK	PS, FPP	125	

## Configuration Files

Use the following table to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal file (.hex) or tabular text file (.tcf) format, have different file sizes.

For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size.

<sup>(221)</sup> To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the “Initialization” section of the *Configuration, Design Security, and Remote System Upgrades in Arria V Devices* chapter.

<sup>(222)</sup> To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus II software from the **General** panel of the **Device and Pin Options** dialog box.